

REMARKS

Claims 1-78 are pending in the application. Responsive to the species restriction in the Office Action, Applicant hereby elects without traverse Embodiment I corresponding to Fig. 1 of the present specification. Applicant asserts that claims 1-78 read on Embodiment I.

Reference to portions of the present specification corresponding to Fig. 1 reveals that claims 1-33 and 52-58 clearly read upon the structure shown in Fig. 1.

Applicant notes that paragraph [0022] of the present specification sets forth that underlayer 14 may be conductive. Paragraph [0022] also states that a storage node included in substrate 12 of Fig. 1 is not shown. Accordingly, claims 34-41 and 59-63 setting forth a storage node, a composite electrode comprising an underlying conductive layer, and the other features of Fig. 1 also read upon Fig. 1.

Applicant also notes that paragraphs [0022] to [0026] of the present specification set forth that underlayer 14 may include a nitride. As supported by claims 43 and 65 and paragraph [0040], the barrier layer of claims 42 and 64 may also include a nitride. Accordingly, claims 42-51 and 64-70 setting forth a barrier layer and the other features of Fig. 1 also read on Fig. 1.

Applicant further notes that paragraphs [0001] and [0007] of the present specification support the structure shown in Fig. 1 as constituting part of a memory device and/or a computer system, such as set forth in claims 71-78. At least for such reason, claims 71-78 setting forth a memory device and/or a computer system and the other features of Fig. 1 also read on Fig. 1.

As already asserted above, underlayer 14 of Fig. 1 may be a nitride layer, as set forth in claims 71, 72, 75, and 76. As also already asserted above, underlayer 14 of Fig. 1 may be conductive, as set forth in claims 73, 74, 77, and 78.

At least for the reasons indicated herein, Applicant requests consideration of claims 1-78 in the next Office Action.

Respectfully submitted,

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